



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Satyavolu S. Papa Rao, et al. Docket No: TI-35916

Serial No:

10/649,256

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Examiner:

Thanh T. Nguyen

Art Unit:

2813

Filed:

08/27/2003

For:

MULTILAYER INTEGRATED CIRCUIT COPPER PLATEABLE BARRIERS

AMENDMENT UNDER 37 C.F.R. § 1.111

Commissioner For Patents P.O. Box 1450 Alexandria, VA 22313-1450 MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(a)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service with sufficient postage

Dear Sir:

Responsive to the Office Action mailed April 1, 2004, in connection with the above identified application, Applicants respectfully submit the following amendments and remarks.